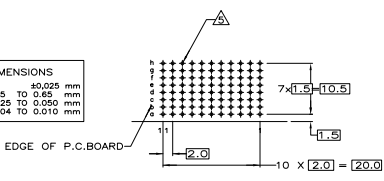


PCB HOLE DIMENSIONS	
DRILLED HOLE	0.7 ±0.025 mm
FIN. HOLE	2.55 TO 0.65 mm
Cu-thks	0.025 TO 0.050 mm
SnPb-thks	0.004 TO 0.010 mm



RECOMMENDED PCB HOLE LAYOUT
 COMPONENT SIDE
 SCALE 2.5:1

- ▲ MATERIAL:
 CONTACT: PHOSPHOR BRONZE.
 HOUSING: GLASS-FILLED POLYESTER.
- ▲ GENERAL PLATING SPECIFICATION: UNDERPLATING
 (ENTIRE CONTACT): 1.27µm MIN NICKEL AND ACTION
 FIN: 0.5µm MIN TIN.
 FOR PLATING OF MATING SURFACES SEE APPLICABLE
 SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- ▲ CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101
 PERFORMANCE LEVEL 2.
- ▲ CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL 3,
 CENTRAL OFFICE APPLICATIONS.
- ▲ PLATED THROUGH HOLES AT 2x1.5mm GRID, 88 TOTAL HOLES.
- ▲ CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT.
 TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- ▲ CONNECTOR PRINTED WITH PART NUMBER AND DATE CODE THIS SIDE.
 ADDITIONAL CHARACTERS OR MARKINGS, AS WELL AS THE LOCATION OF THE MARKINGS,
 MAY BE ADDED FOR TRACEABILITY BASED UPON MANUFACTURERS DISCRETION.
- ▲ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- ▲ 0.76µm MIN GOLD PLATING ON MATING SURFACES

▲	3-646446-0
▲	-646446-9-
▲	646446-1
▲	FINISH
▲	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		REVISED	DATE	BY	APP'D
DESIGNED	BY	DATE	BY	APP'D	
DRAWN	BY	DATE	BY	APP'D	
CHECKED	BY	DATE	BY	APP'D	
APPROVED	BY	DATE	BY	APP'D	
DATE	SIZE	SCALE	DRAWING NO.	REVISED TO	
			A1 00779 G=646446		
CUSTOMER DRAWING		DATE	SCALE	SHEET	OF
				1	1